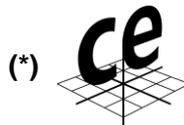


GetDP Workshop, 22–23 April 2021

<https://indico.cern.ch/event/1015906/>

Transient Effects in Accelerators, Scalability and Large Models

L. Bortot^{1,2}, M. Mentink¹, S. Schöps², A. Verweij¹



This work is supported by:

(*) Graduate School CE within the Centre for Computational Engineering at Technische Universität Darmstadt.

(**) The Gentner program of the German Federal Ministry of Education and Research (grant no. 05E12CHA).

Acknowledgments

Contents from research activity over the past three years.
These results would not have been possible without your support!



I.C. Garcia, H. de Gersem



*J. van Nugteren, C. Petrone, G. Deferne, T. Koettig,
J.C. Perez, F.O. Pincot, G. de Rijk, S. Russenschuck,
G. Kirby, M. Pentella, M. Maciejewski*

PAUL SCHERRER INSTITUT



B. Auchmann

... and many thanks to the
workshop organizers for the invitation!

Outline

I. Introduction

- a. High-Temperature Superconductors
- b. Dynamic effects in conductors, magnets, circuits

II. Method

- a. Coupled A-H Field Formulation
- b. Field-Circuit Coupling Interface
- c. Waveform Relaxation Scheme

III. Large scale applications (selected examples):

- a. Quench in an HTS Solenoid
- b. Dynamic field quality in the HTS dipole Feather-M2
- c. Quench in a simple NI coil
- d. Prototyping new stuffs – HALO

IV. Summary and Outlook

Introduction

Method

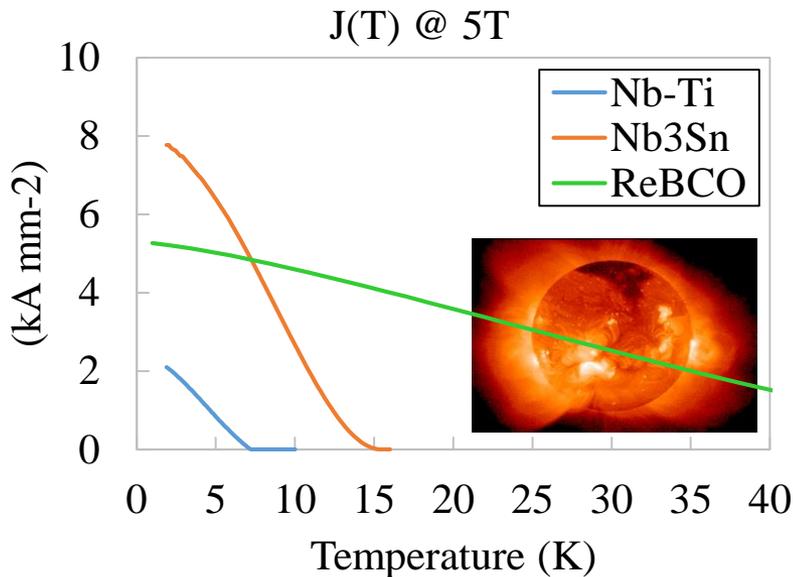
Large Scale Examples

Summary And Conclusions

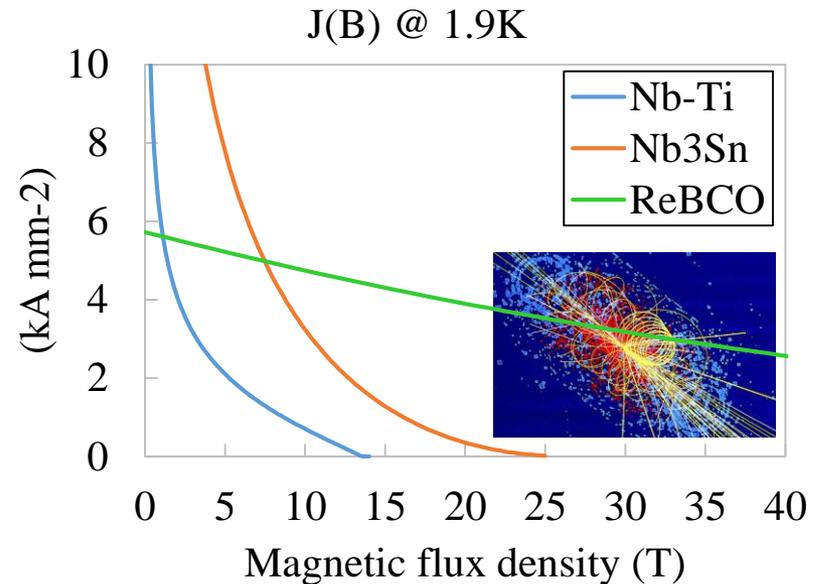
HIGH TEMPERATURE SUPERCONDUCTORS

Copper oxides (CuO_2) doped with rare earths (La, Bi-Sr-Ca, Y-Ga-Ba etc.)

Higher critical temperature and upper critical field with respect to the traditional low-temperature superconductors (LTS), such as Nb-Ti or Nb₃Sn



High-thermal load applications

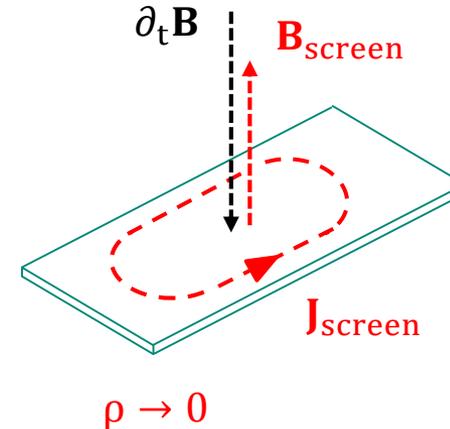
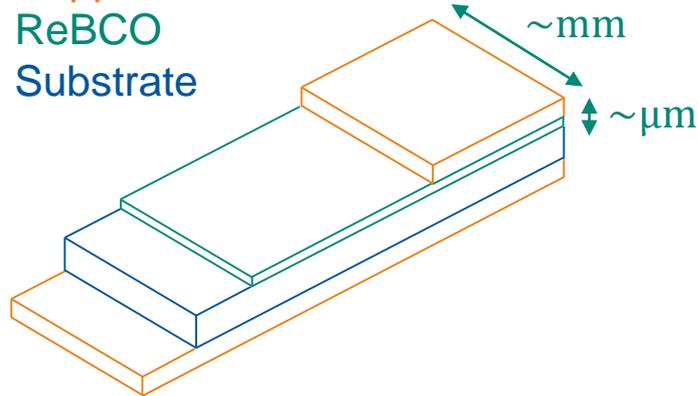


High-field applications

SCREENING CURRENTS

HTS tape in a time-dependent magnetic field $\partial_t \mathbf{B}$:

- Copper
- ReBCO
- Substrate



$\partial_t \mathbf{B} \rightarrow$ Screening currents $\mathbf{J}_{\text{screen}}$

$\rho \rightarrow 0 \rightarrow$ Persistent magnetization $\mathbf{B}_{\text{screen}}$

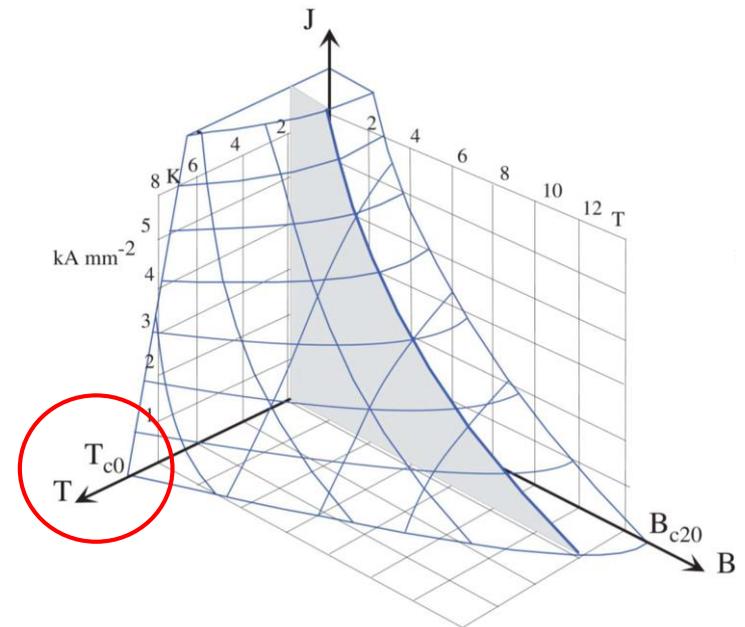
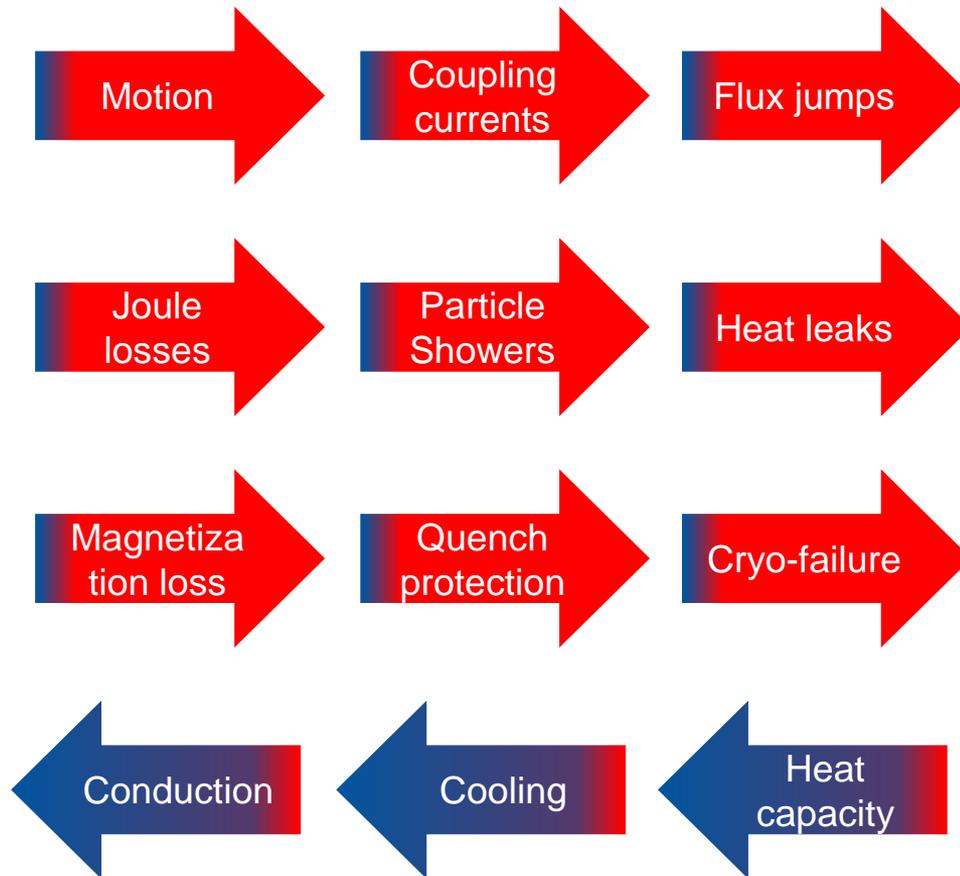
Large filament size (5-12 mm) \rightarrow large $\mathbf{B}_{\text{screen}}$

Magnetic field quality and thermal behavior, as principal Joule loss contribution

Inhomogeneous current density distribution \rightarrow Detrimental impact on field quality

THERMAL DYNAMICS

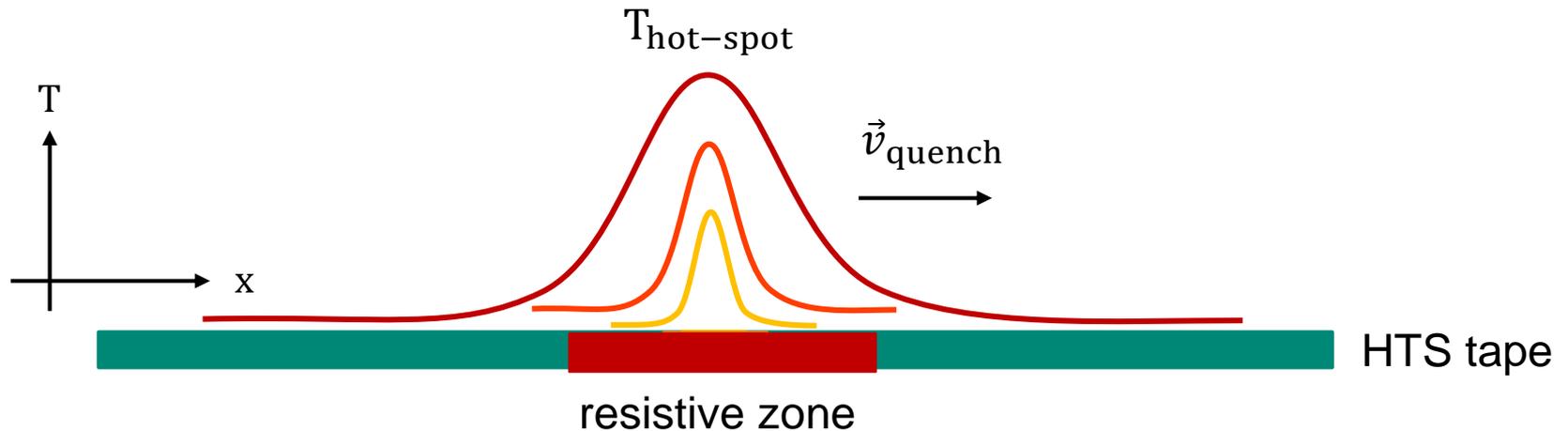
Main contributors to the thermal dynamic of superconducting materials in accelerators:



Nb-Ti critical current density surface $J_c(T, B)$

QUENCH

Local transition from superconducting to normal conducting state



Energy dissipated in the resistive zone

Potentially **irreversible effects** for high energy-density devices (accelerator magnets)!

HTS characteristics:

- **low heat diffusivity**
- **low \vec{v}_{quench}** , small resistive zone, difficult to detect
- **high $T_{\text{hot-spot}}$** , potential damage in short time (tens of ms)

DYNAMIC EFFECTS IN ACCELERATORS (1/2)

Magnets (e.g. MB magnet)

$\sim 10^2$ coil turns, $\sim 10^4$ strands

Magnetic: magnetization, IFCC, ISCC, EM crosstalk...

Thermal: magnetization, IFCL, ISCL, quench, coolant...

Mechanic: Lorentz forces, thermal strain...

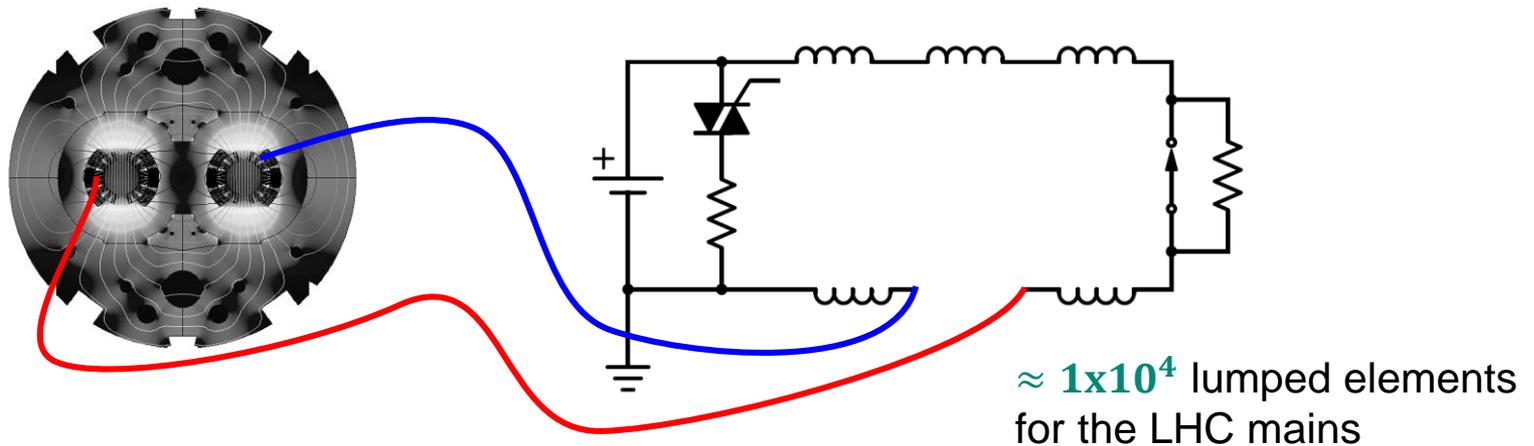
Circuit (e.g. LHC mains)

7 km long, 154 Magnets

Topological: Switches, thyristors, diodes

Electrical: Propagative phenomena, dynamic impedances (magnets), EM crosstalk

• ...

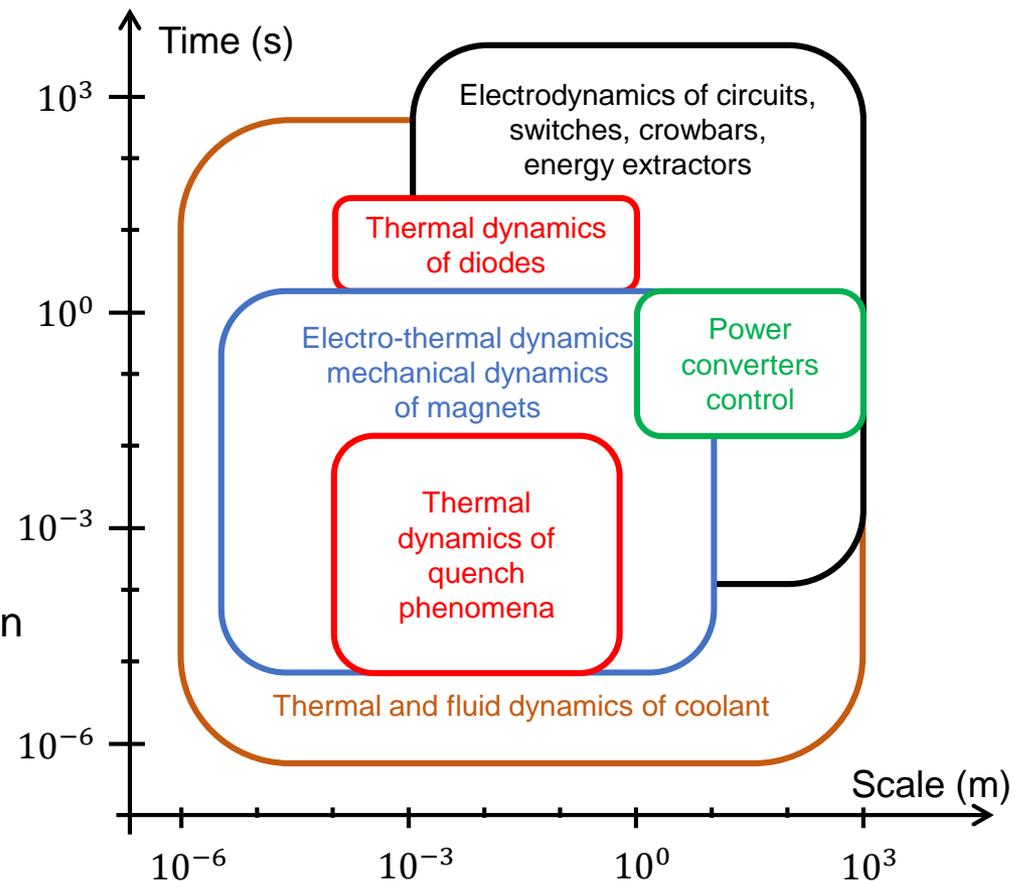


Field-Circuit Coupled Systems!

DYNAMIC EFFECTS IN ACCELERATORS (2/2)

Simulation challenges

- Complex components
- Cutting-edge technologies
- Physical size of devices
- Extreme ambient conditions
- Extremely fast phenomena (e.g. beam dynamics)
- ...
- Mutual electro-thermo-dynamic interaction between circuit, power converters, magnets and protection systems



multi-physics multi-scale and multi-rate

Introduction

Method

Large Scale Examples

Summary And Conclusions

FORMULATION

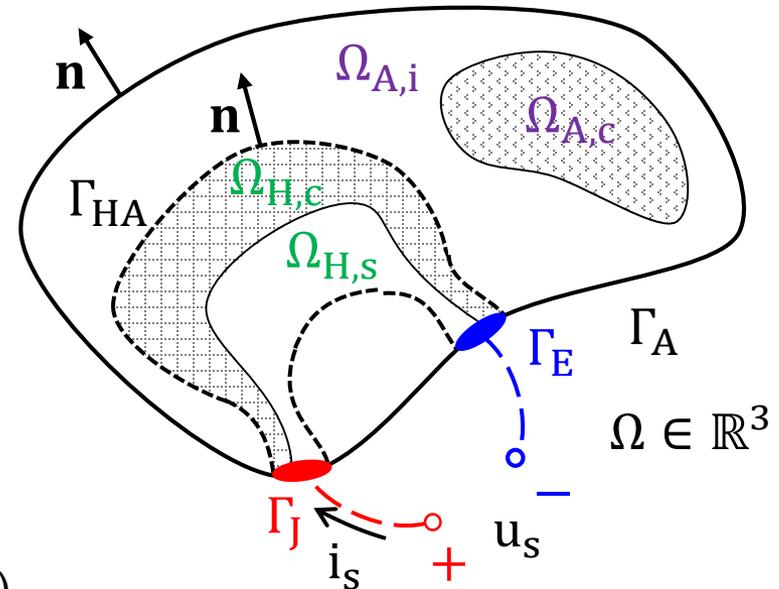
Magnet domain decomposition

$\Omega_H = \Omega_{H,s} \cup \Omega_{H,c}$ source region (coils):

- $\Omega_{H,s}$ superconductors ($\sigma \rightarrow +\infty$)
- $\Omega_{H,c}$ normal conductors

$\Omega_A = \Omega_{A,c} \cup \Omega_{A,i}$ passive region (Iron, air):

- $\Omega_{A,c}$ normal conductors
- $\Omega_{A,i}$ insulators ($\rho \rightarrow +\infty$)



Field equations (see also Julien's presentation)

$$\nabla \times \rho \nabla \times \mathbf{H} + \mu \partial_t \mathbf{H} + \nabla \times \boldsymbol{\chi} u_s = 0$$

\mathbf{H} formulation in Ω_H

$$\nabla \times \nu \nabla \times \mathbf{A}^* + \sigma \partial_t \mathbf{A}^* = 0$$

\mathbf{A}^* formulation in Ω_A

$$\rho_m C_p \partial_t \mathbf{T} - \nabla \cdot \mathbf{k} \nabla \mathbf{T} - \mathbf{J} \cdot \rho \mathbf{J} = 0$$

Heat balance equation \mathbf{T} in Ω

$$\int_{\Omega_H} \boldsymbol{\chi} \cdot \nabla \times \mathbf{H} d\Omega = i_s$$

Current constraint

$$\boldsymbol{\chi} = -\nabla \xi, \quad \xi: \nabla \cdot \sigma \nabla \xi = 0$$

Voltage distribution function

SEMI-DISCRETE PROBLEM

Discretization functions

- Edge elements for \mathbf{H} , \mathbf{A}^* (1st and 2nd order)
- Nodal elements for χ , T (1st order)

$$\begin{bmatrix}
 \mathbf{K}^\nu + \mathbf{M}^\sigma \frac{d}{dt} & -\mathbf{Q} & \mathbf{0} & \mathbf{0} \\
 \mathbf{Q}^T & \mathbf{K}^\rho + \mathbf{M}^\mu \frac{d}{dt} & -\mathbf{X} & \mathbf{0} \\
 \mathbf{0} & \mathbf{X}^T & \mathbf{0} & \mathbf{0} \\
 \mathbf{0} & \mathbf{0} & \mathbf{0} & \mathbf{K}^\kappa + \mathbf{M}^\rho \frac{d}{dt}
 \end{bmatrix} \cdot \begin{bmatrix} \mathbf{a} \\ \mathbf{h} \\ \mathbf{u}_s \\ \mathbf{t} \end{bmatrix} = \begin{bmatrix} \mathbf{0} \\ \mathbf{0} \\ \mathbf{i}_s \\ \mathbf{q}(\cdot) \end{bmatrix}$$

A* form
H-form
Field coupling
Heat Balance
Circuit coupling

Finite material properties, bounded condition number → Solver stability 😊

Observations:

- Electric ports Γ_J and Γ_E as connections with the external circuit
- $\mathbf{u}_s, \mathbf{i}_s \rightarrow r$ -th winding as one-port component, with impedance Z_r : $u_r = Z_r i_r$

FIELD-CIRCUIT COUPLING

Interface derivation

Schur complement applied in the semi-discrete problem

Assumption $\mathbf{K}^v + \lambda \mathbf{M}^\sigma$ positive-definite (true for gauged \mathbf{A}^*) \rightarrow Invertible

Interface derived as optimal Schwarz transmission condition for linear systems

$$\mathbf{Z}(j\omega) = [\mathbf{X}^T [\mathbf{K}^\rho + j\omega \mathbf{M}^\mu + \mathbf{Q}^T [\mathbf{K}^v + j\omega \mathbf{M}^\sigma]^{-1} \mathbf{Q}]^{-1} \mathbf{X}]^{-1}$$

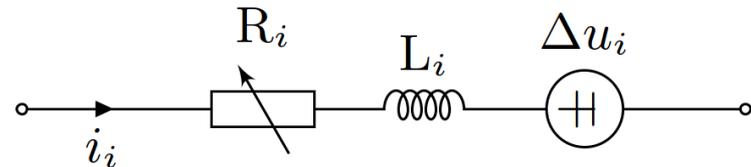
↓ ↓ ↓ ↓

resistive term **H**-flux **A**^{*}-flux eddy currents term

Approximation of derivatives in time domain (e.g. Taylor expansion series)

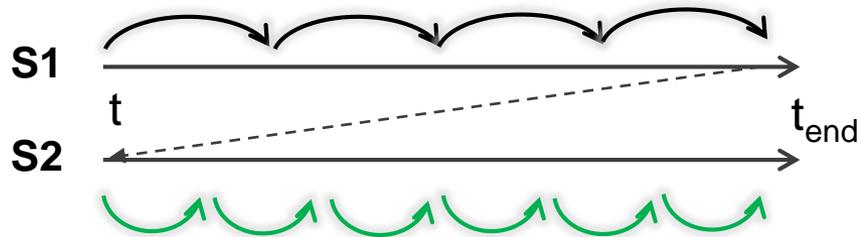
$$\mathbf{Z}(j\omega) \approx \mathbf{Z}(0) + j\omega \left. \frac{\partial \mathbf{Z}(j\omega)}{\partial j\omega} \right|_{j\omega=0}$$

$$\mathbf{u}_s \approx \mathbf{R} \mathbf{i}_s(t) + \mathbf{L} \frac{d}{dt} \mathbf{i}_s(t)$$

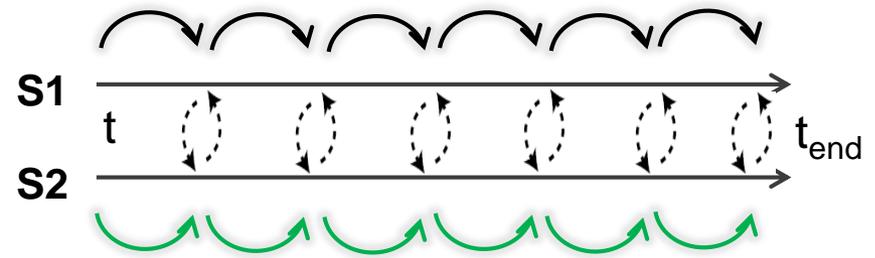


TIME-DOMAIN COUPLING

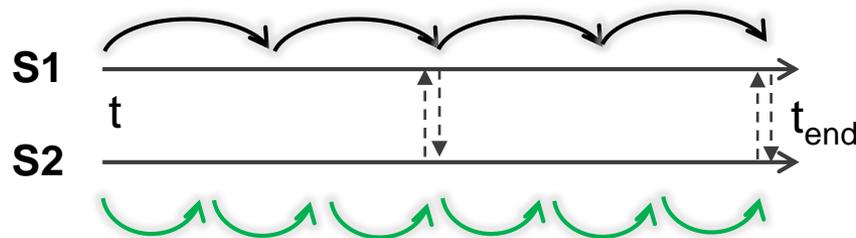
One-way coupling / Parameter extraction



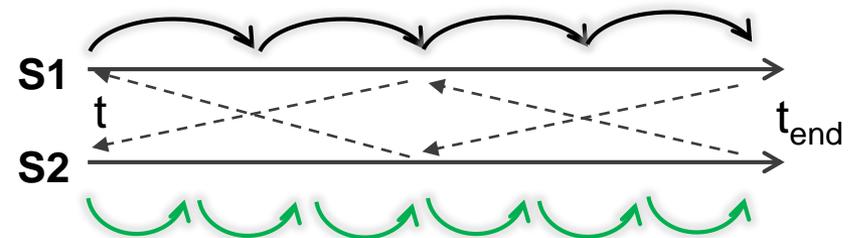
Strong coupling



Weak coupling



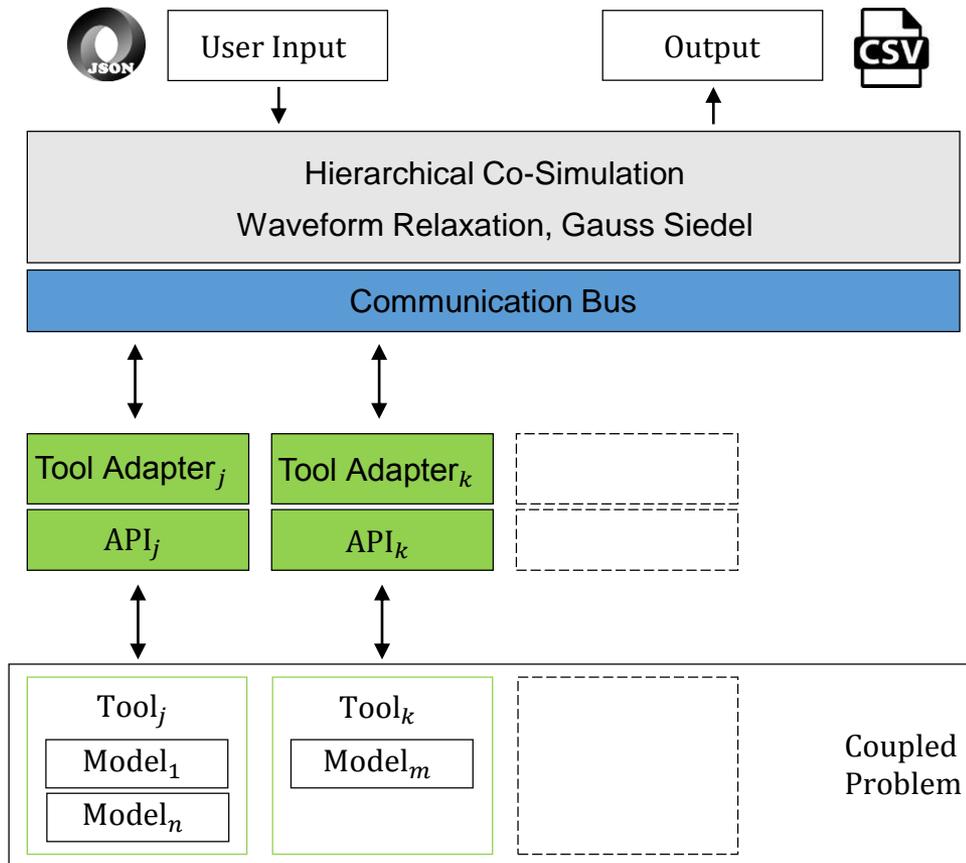
Waveform relaxation / Dynamic iteration



Multirate systems

- Fast System \rightarrow small steps, slow System \rightarrow large steps
- Different time steps for efficiency
- Different solvers since different nature of the problem

COSIMULATION FRAMEWORK



Top Layer

- Hierarchical co-simulation algorithm
- Waveform relaxation, Gauss-Seidel scheme

Middle Layer

- Communication bus, common interface
- Standard set of rules for data exchange

Bottom Layer

- Interpreter (framework vs. simulation tools)
- Tool-oriented (single adapter for multi-models)

STEAM (*)

Lean, Modular, Expandable



(*) <https://espace.cern.ch/steam>

REMARKS

Strong form: $F(r, t) = 0$ in Ω

Weak form: $\int F(r, t) \cdot w \, d\Omega = 0$

Semi-discrete form: $F_i \int w_i \cdot w_j \, d\Omega = 0$ with $F(r, t) \approx \sum w_i F_i$

↓
Space discretization and time-integration
via **FEM solvers**

Weak field formulation → general description of the field problem

Well-documented coupling interfaces → ready to be used

Tool adapters in the co-simulation framework → tool independent

Numerical examples in COMSOL, but **the approach is completely general!**

Introduction

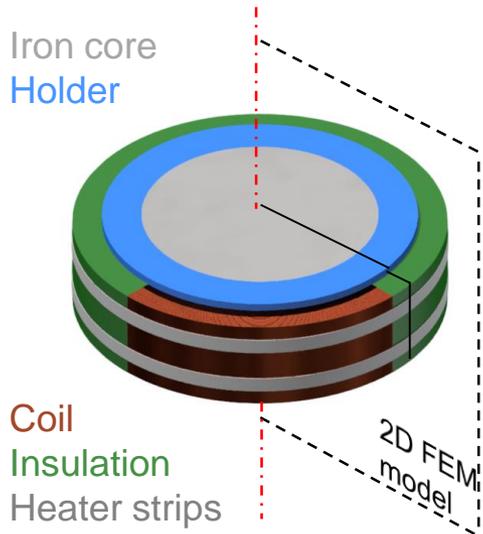
Methods

Large Scale Examples

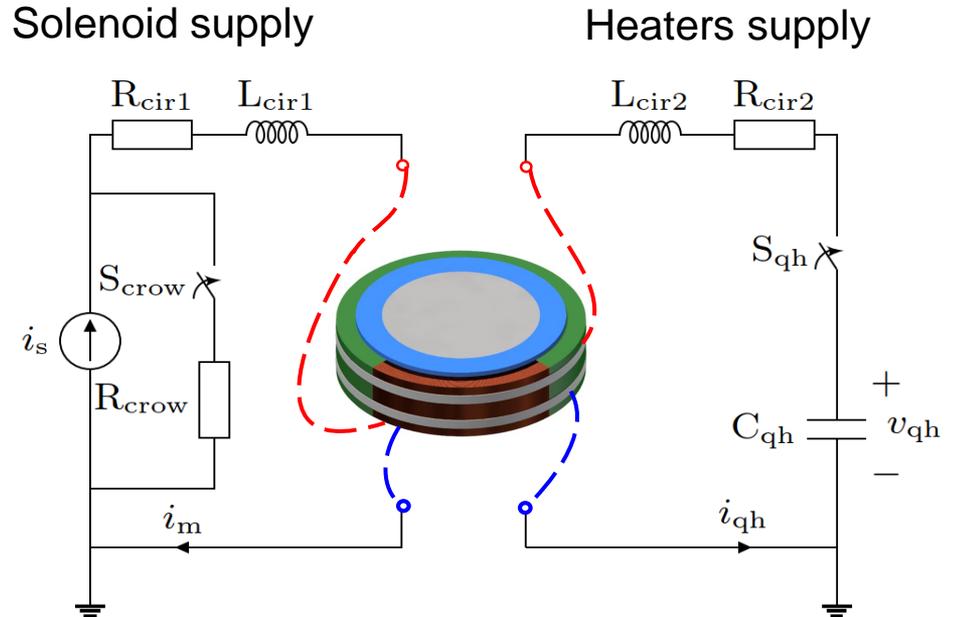
Summary And Conclusions

(A) PROBLEM SETTING

HTS solenoid protected by quench heaters



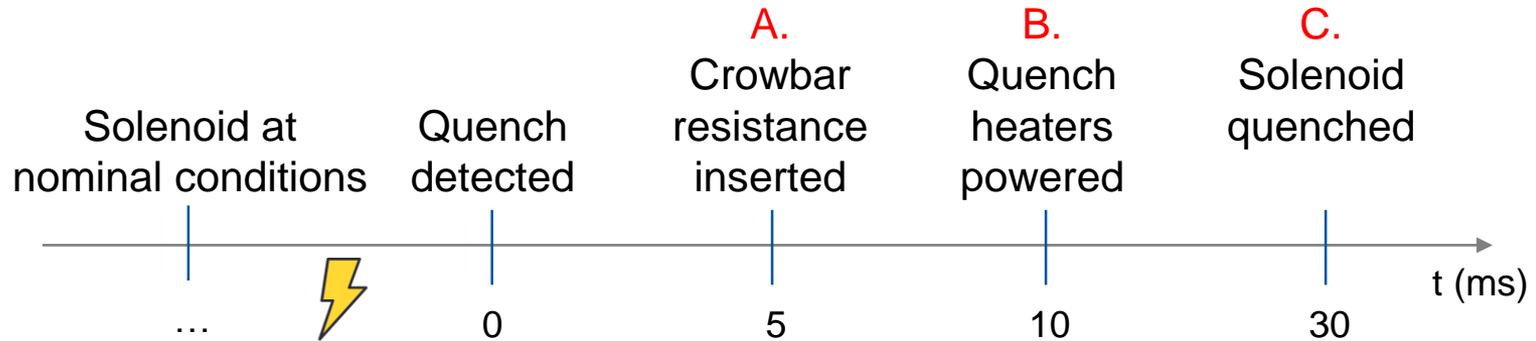
Rendering of the HTS solenoid (*)



Electrical layout (**)

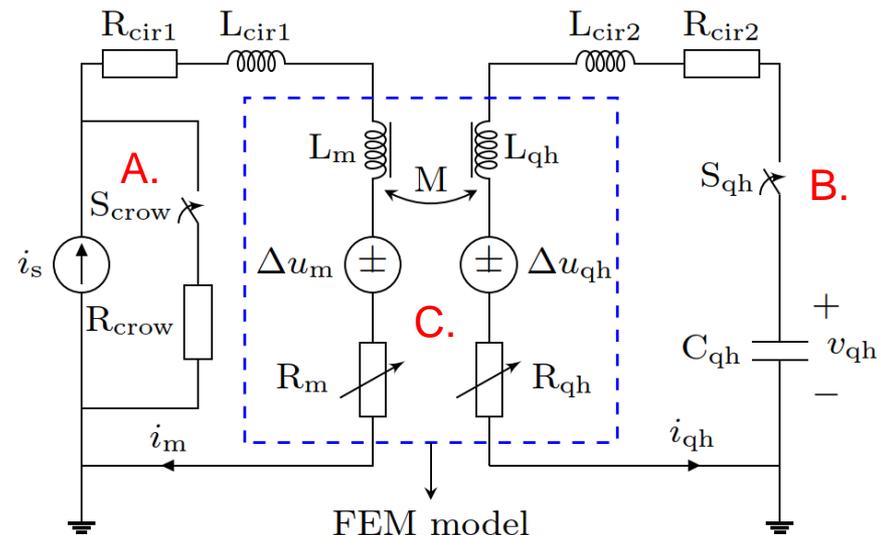
Electro-magneto-thermal coupling between the solenoid and the quench heaters!

(A) SIMULATION SETUP



$R_{\text{crow}} + R_m$ discharge the current in the solenoid, limiting the peak temperature in the superconducting coil

R_m determined by the quench dynamics within the solenoid

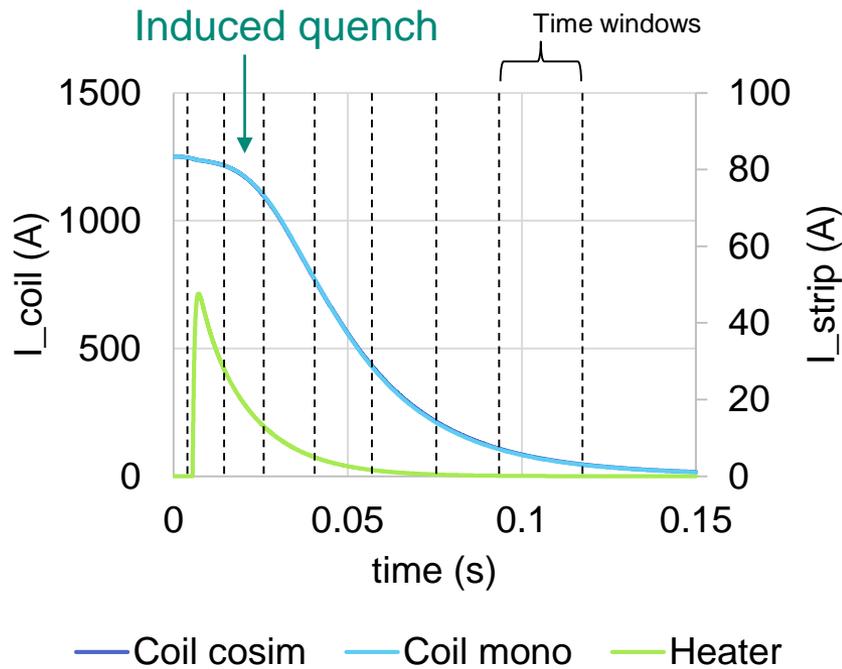


COMSOL

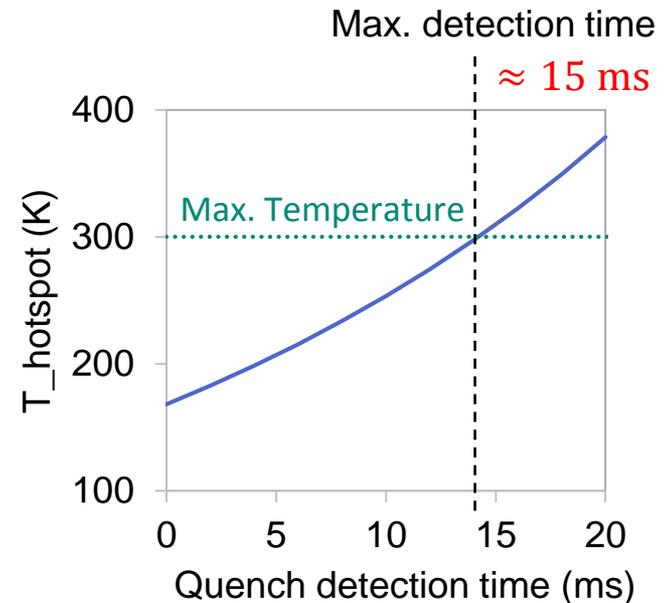
LTspice

(A) NUMERICAL RESULTS (1/2)

Circuital currents



Peak temperature

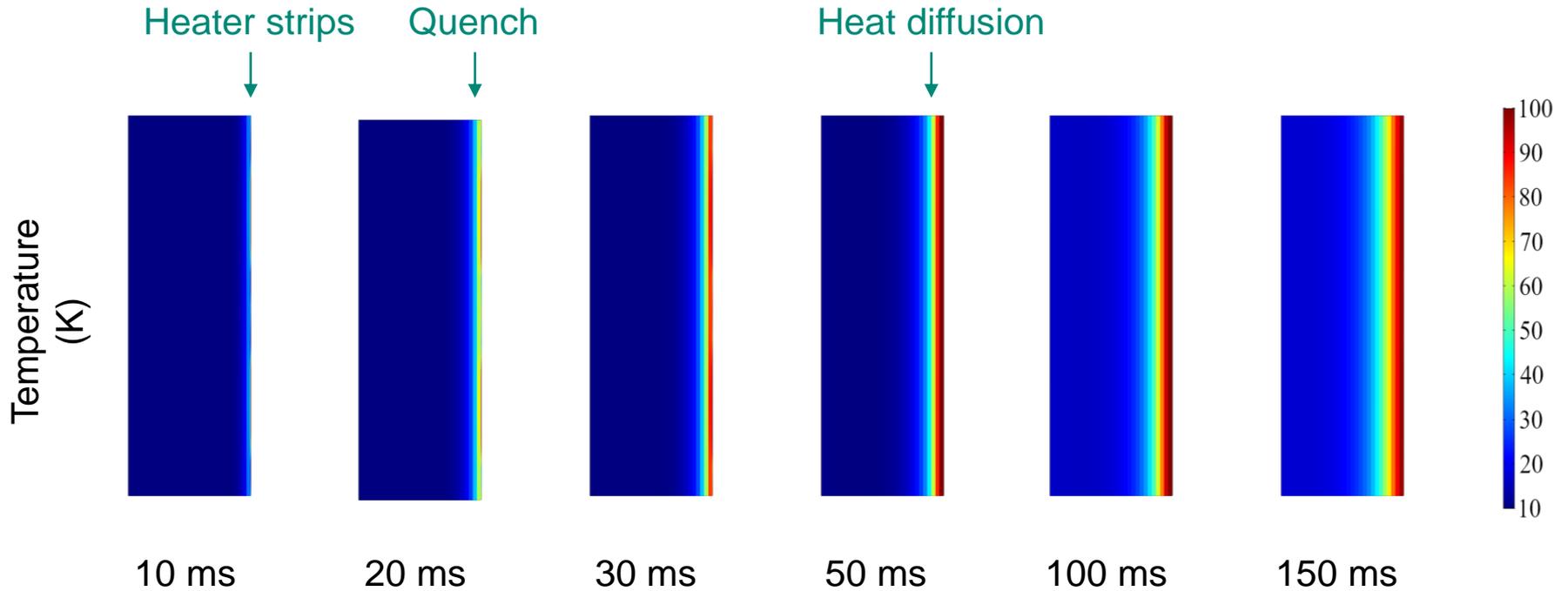


Current decay in the coil (left) and current discharge in the heater strips (right)

Adiabatic hotspot temperature in the coil, as a function of the quench detection time

(A) NUMERICAL RESULTS (2/2)

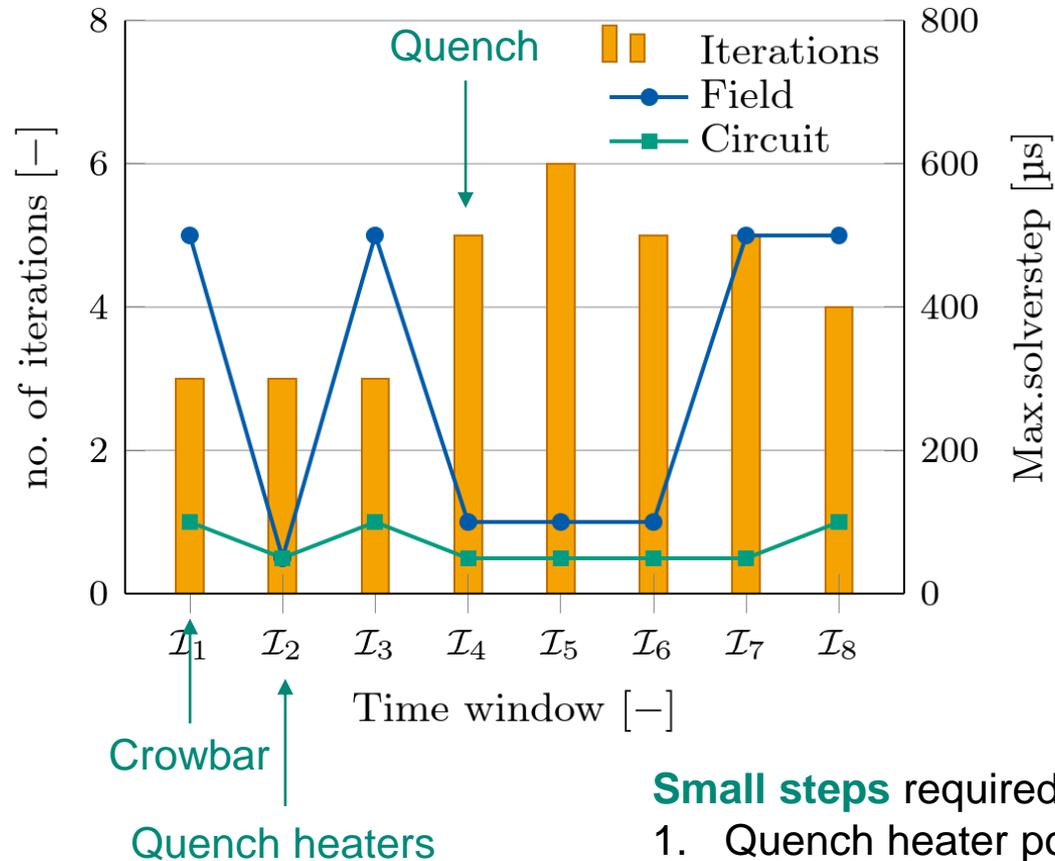
Temperature in the coil cross section



Temperature distribution in the superconducting coil, as a function of time

(A) TIME STEPPING

Maximum time step for each solver, for each time window



- Small steps** required for:
1. Quench heater powering
 2. Quench transition

(B) PROBLEM SETTING (1/3)

Feather-M2 HTS insert dipole magnet

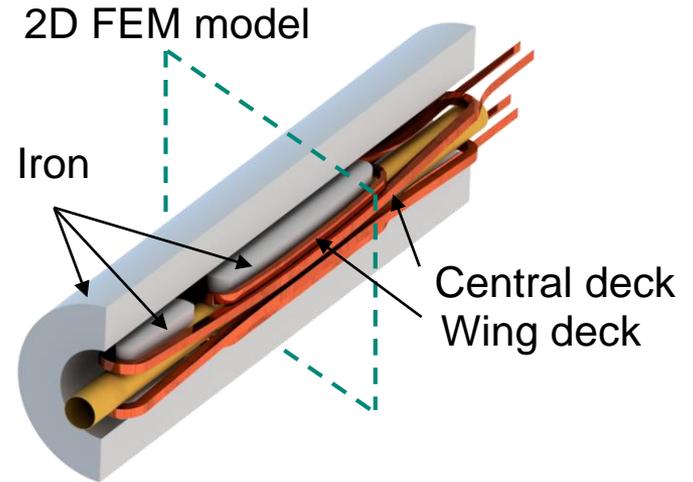
Main features:

- Aligned coil concept
- Coil made of two central and wing decks
- Roebel cable, fully transposed tapes

2D model:

- Layer jumps \rightarrow 4-quadrant
- 48 turns, 720 tapes

Cable cross section

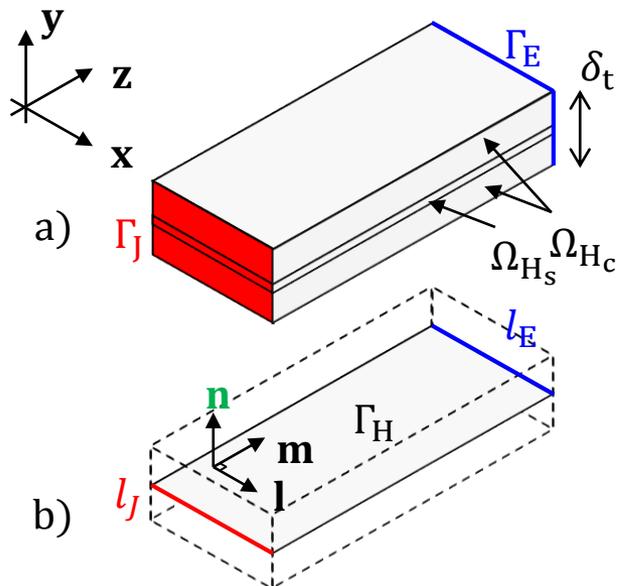


(B) PROBLEM SETTING (2/3)

Thin shell approximation

No current density variation along δ_t

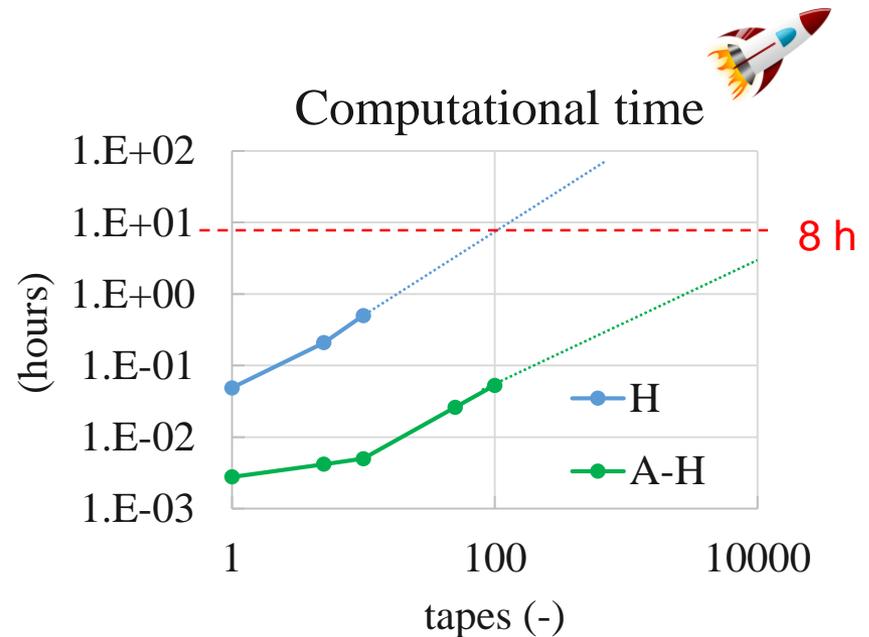
Homogenized resistivity ρ_{eq}



Computational cost (*)

Comparison on a test problem

Tapes stacked on top of each other



Scalar field problem \rightarrow **nodal elements**

Reduction of **two orders of magnitude**

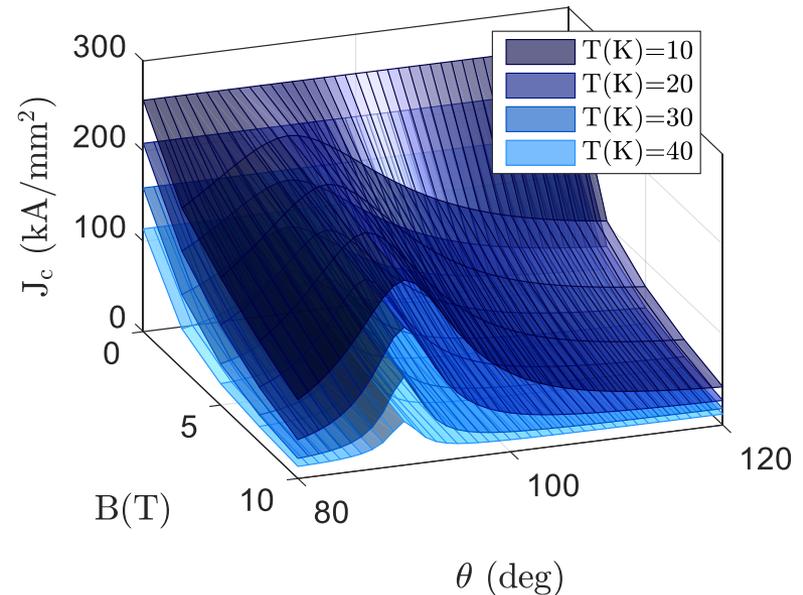
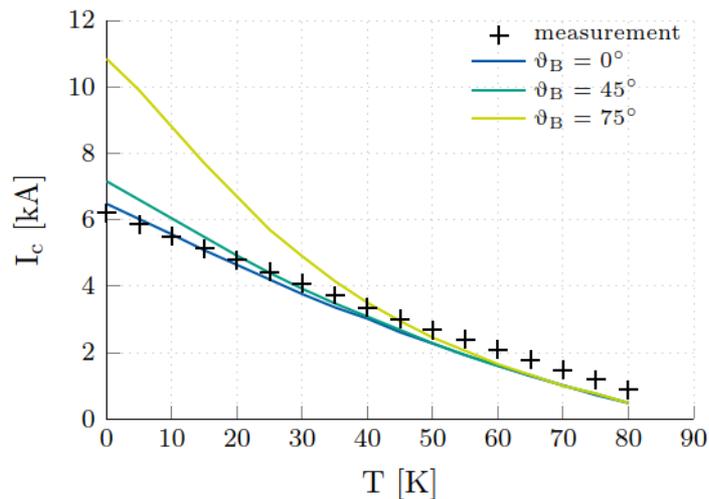
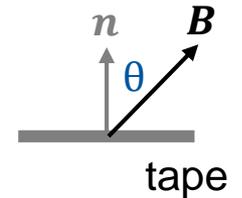
(B) PROBLEM SETTING (3/3)

Modelling of J_c (T , B , θ)

J_c data available only at $T = 77$ K \rightarrow Lift factor

Lift factor calibrated with the measured critical current I_c

Angle dependency gauged at $\theta = 30^\circ$ (magnetostatic simulation)



Anisotropy included in the model, but uncertainty on material properties

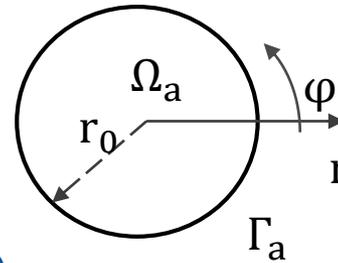
(B) SIMULATION SETUP

Field quality

In the magnet aperture Ω_a , $\Delta A_z = 0$

General Solution: Fourier expansion series

$$B_r(r, \varphi) = \sum_{n=1}^{\infty} \underbrace{nr^{n-1} \gamma_n \cos(n\varphi)}_{A_n(r)} + \underbrace{nr^{n-1} \delta_n \sin(n\varphi)}_{B_n(r)}$$



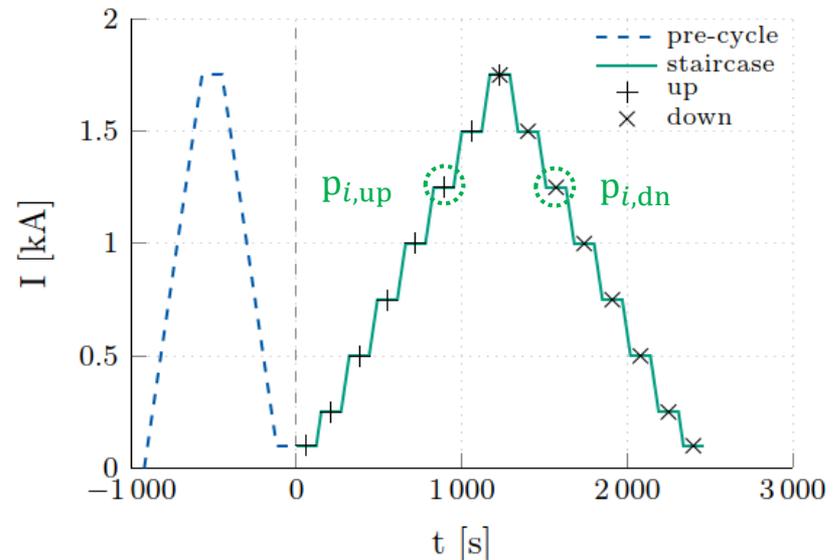
$A_n(r)$, $B_n(r)$ skew and normal magnetic field multipoles calculated along Γ_a

Source current

Pre-cycle \rightarrow first magnetization

Steps of 250 A, plateaus of 120 s:
decay of inductive effects

$\{p_{i,up}, p_{i,dn}\}$ Evaluation points

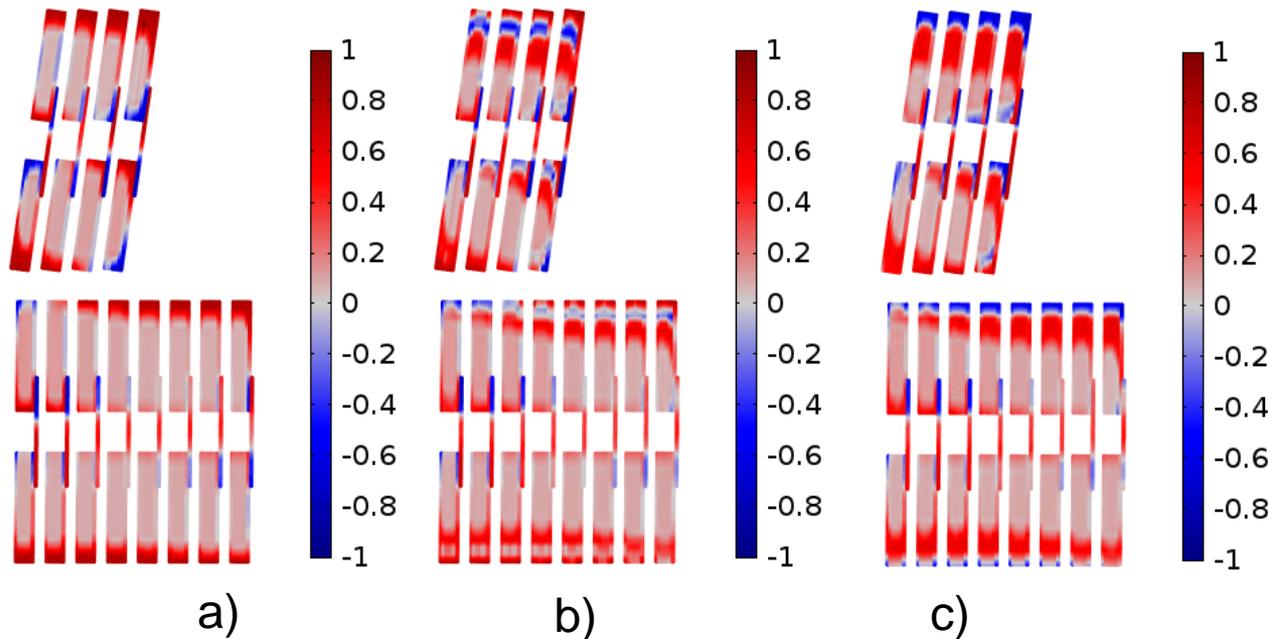
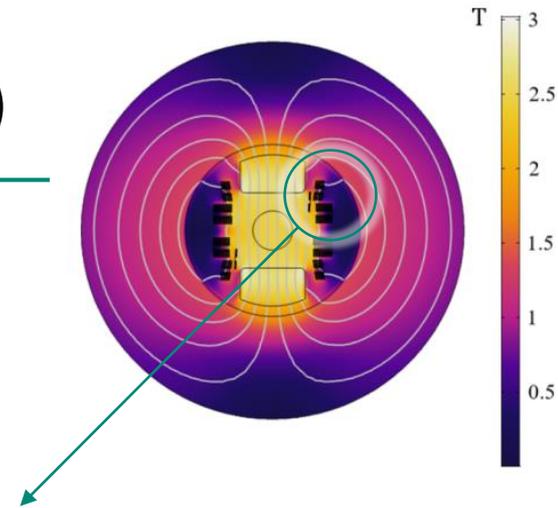


(B) NUMERICAL RESULTS (1/2)

Computational time

0.5 h (*) for about 120k DoF

Current density plots: same source current, different time steps

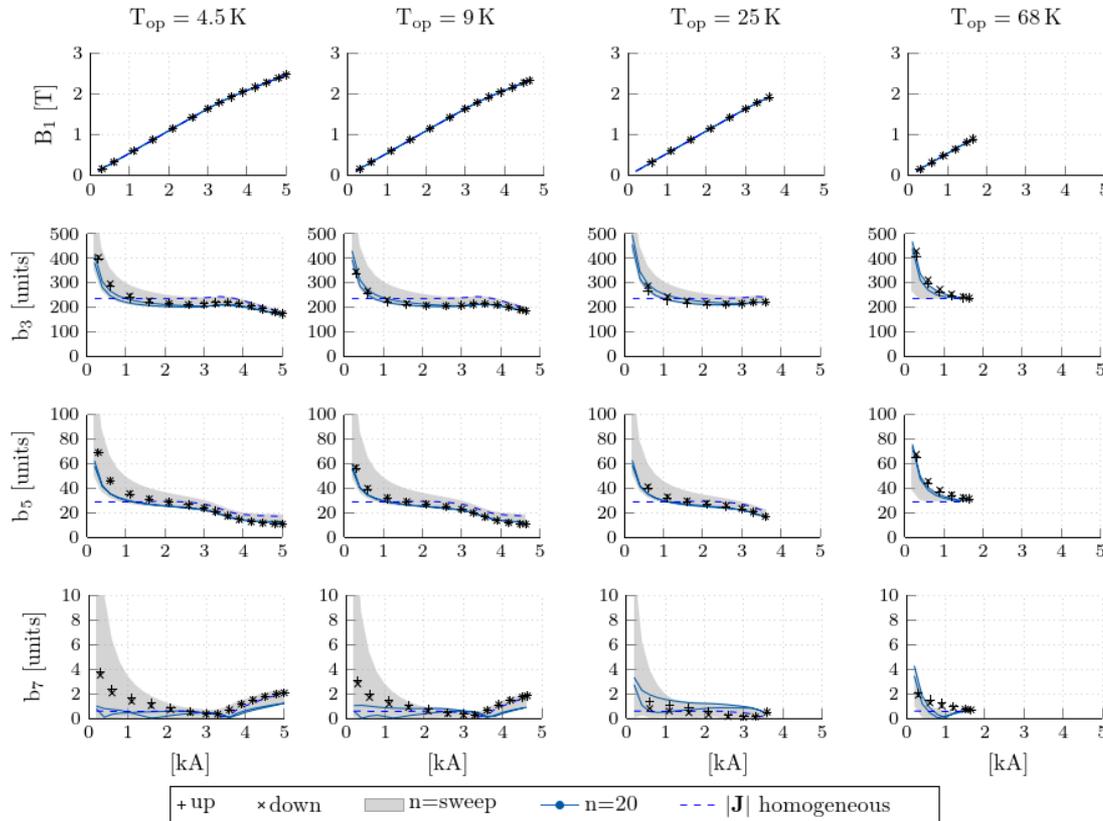


Normalized current density in the coil (first quadrant)

(B) NUMERICAL RESULTS (2/2)

Magnetic field quality

Multipole expansion series as function of current, for different temperatures



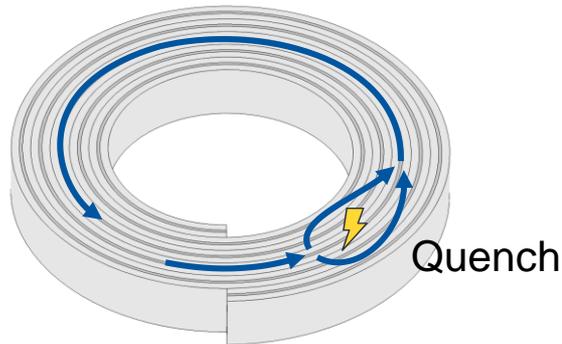
Very good agreement with measurements

(C) PROBLEM SETTING (1/2)

No insulation (NI) coil

Main features:

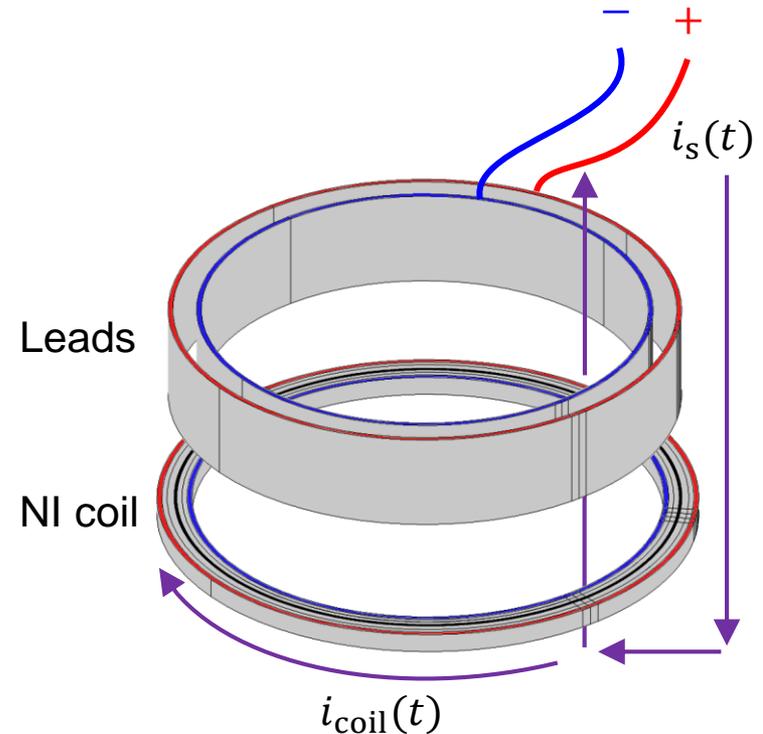
- Current bypass for quench zones
- Limitation of peak temperature
- Large screening currents in field dynamics
- Unbalanced Lorentz forces during quench



Electrical layout

Coil clamped with two copper rings

Leads as two concentric hollow cylinders



(C) PROBLEM SETTING (2/2)

Scale challenge:

ReBCO \ll Tape \ll Coil

Up to tens of pancakes, thousands of turns

Mesh size: $\approx n_{2D} n_{\text{tape}} 2\pi r_{\text{coil}} [\text{mm}] n_{\text{pancake}}$

Example: 100 elements per tape cross section,
100 tapes, 10 mm radius

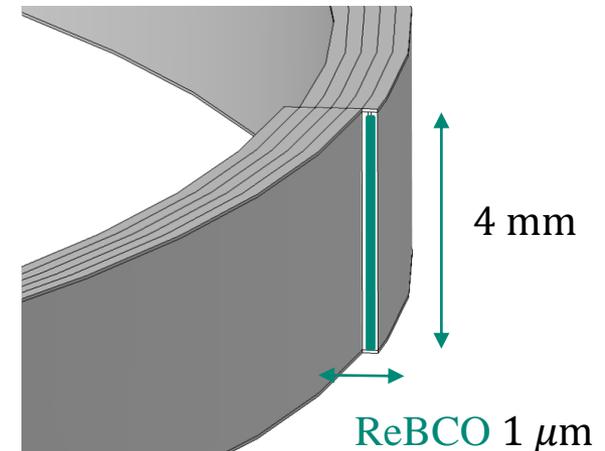
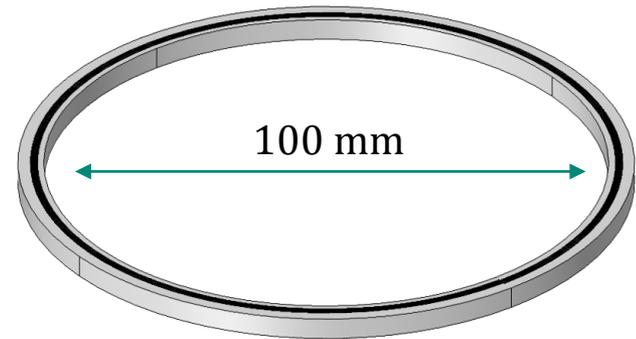
$\rightarrow \approx \sim 10^6$ elements per pancake

Case study:

Five-turns in one pancake

Copper-coated ReBCO tape, no solder

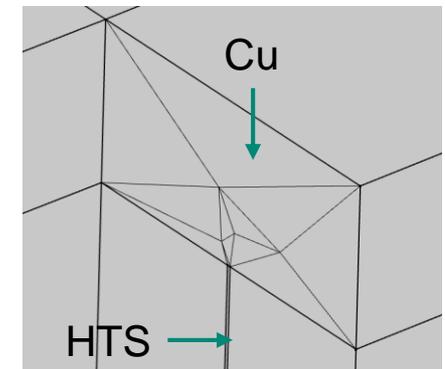
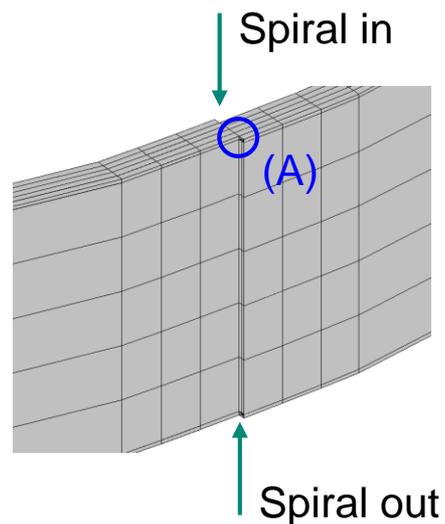
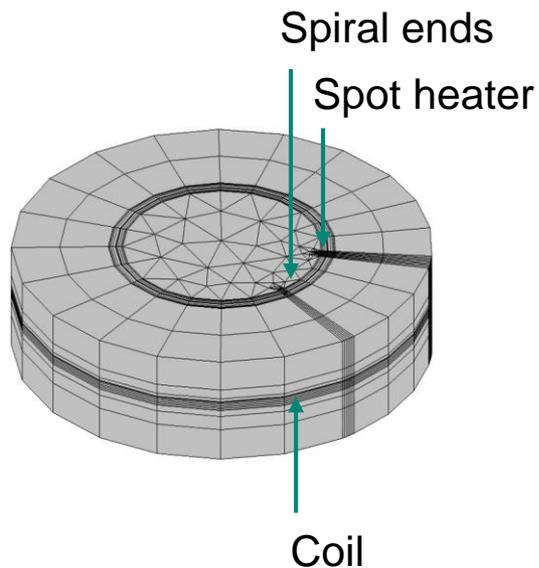
4 mm wide tape, $I_c = 1$ kA



(C) MESH

Main features

- Mapped mesh in the tape cross section
- Triangular mesh in the tape ends
- Hexahedrons and prisms along the coil
- $\sim 4 \times 10^4$ elements, 1.1×10^5 dof

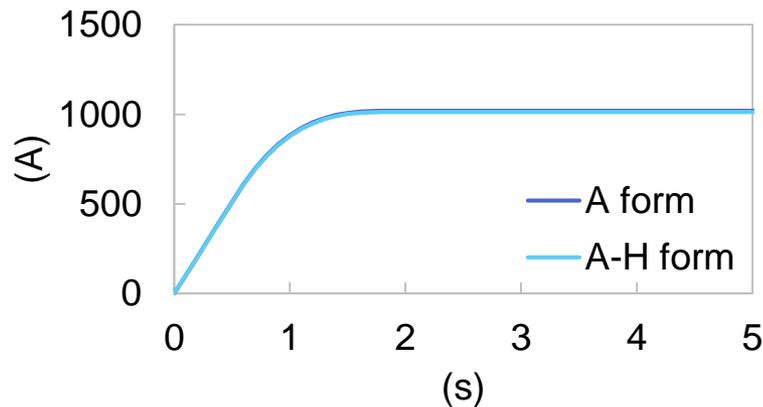


Detail of the tape end (A)

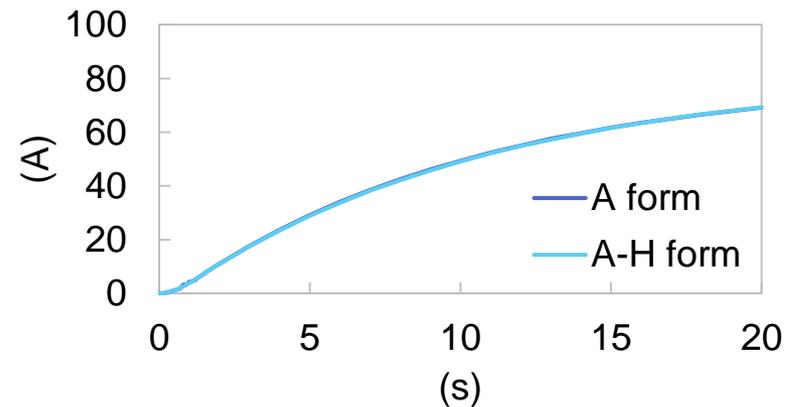
(C) MODEL VERIFICATION

Constant material properties → Speedup, traditional formulations

Comparison with the COMSOL in-built A*-formulation (mf module)



Coil current as a function of time



Detail of the initial coil current

Verification of the implemented equations
not of the behaviour of the superconducting material

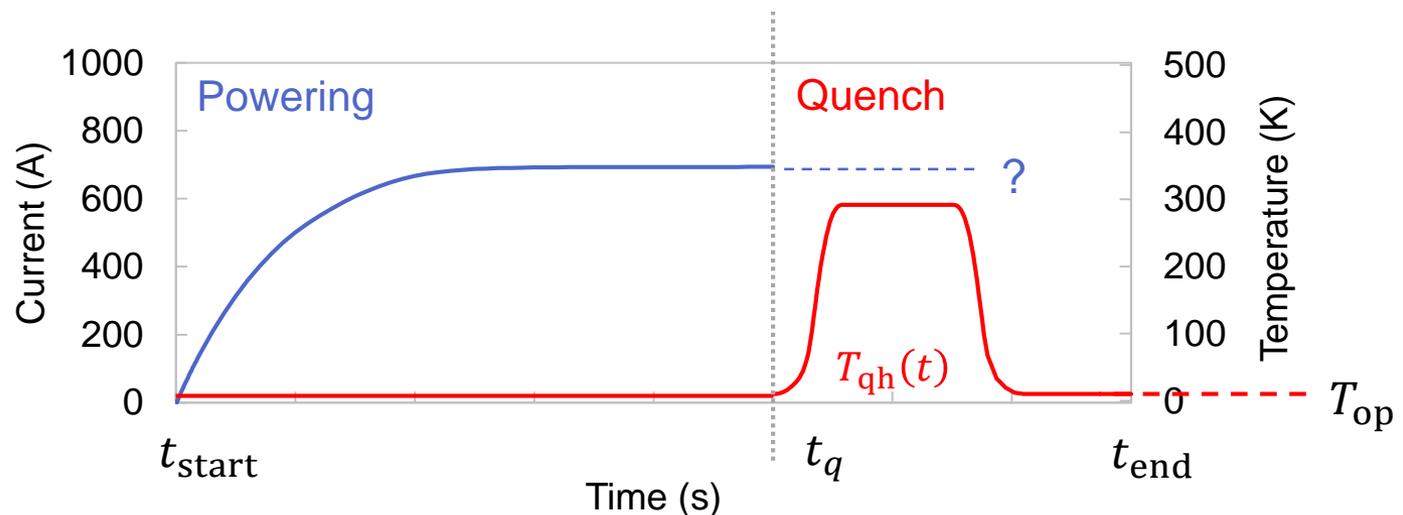
(C) SIMULATION SETUP

Constant voltage U_s applied to the coil:

$$u_s(t) = U_s \quad \forall t \in [t_{\text{start}}; t_{\text{end}}]$$

Spot heater modeled a Dirichlet boundary condition $T_{\Gamma, \text{dir}}(t)$ for temperature:

$$T_{\Gamma, \text{dir}}(t) = \begin{cases} T_{\text{op}} & \text{if } t \leq t_q \\ T_{\text{qh}}(t) & \text{if } t > t_q \end{cases}$$



Current profile at the coil leads

Temperature of the spot heater

(C) NUMERICAL RESULTS (1/2)

Temperature in the spot heater region

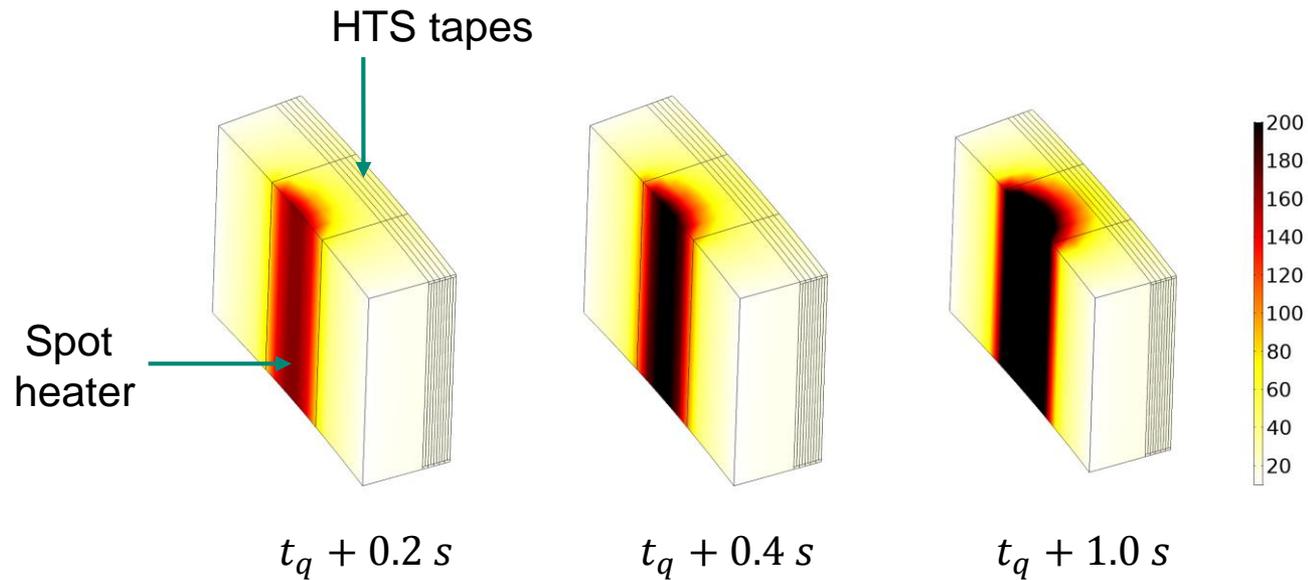


Figure: temperature distribution in the coil, detailed for the spot heater region

(C) NUMERICAL RESULTS (2/2)

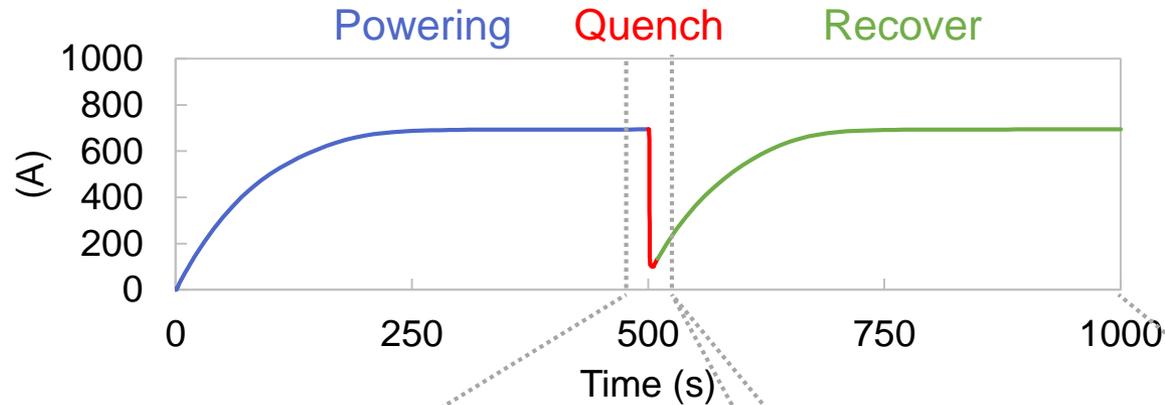
Current dynamics at the coil leads

Computational time (*):

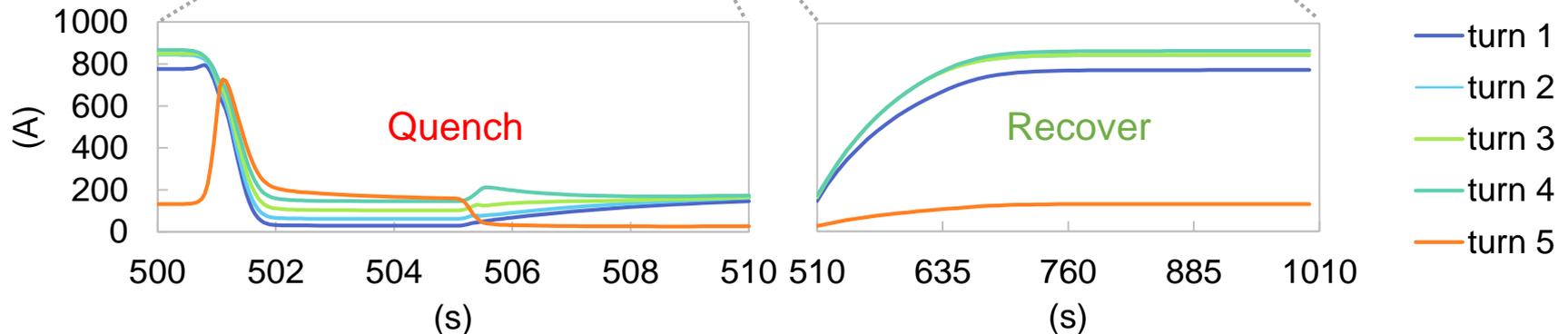
Powering: 20 min

Quench: 50 min

Recover: 15 min



Current redistribution between the tapes (Turn numbering from inside to outside):



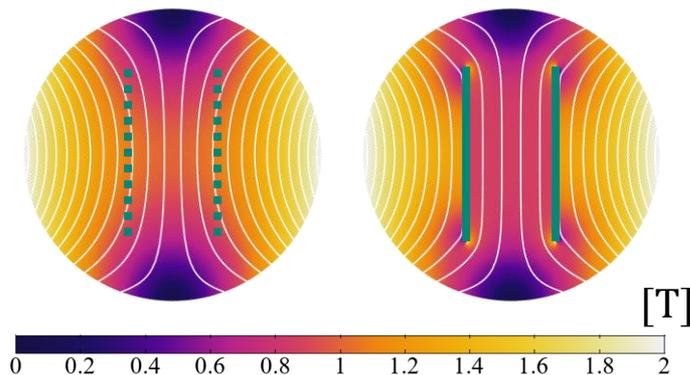
(D) PROTOTYPES DEVELOPMENT (1/2)

HALO:

Harmonics-Absorbing Layered Object

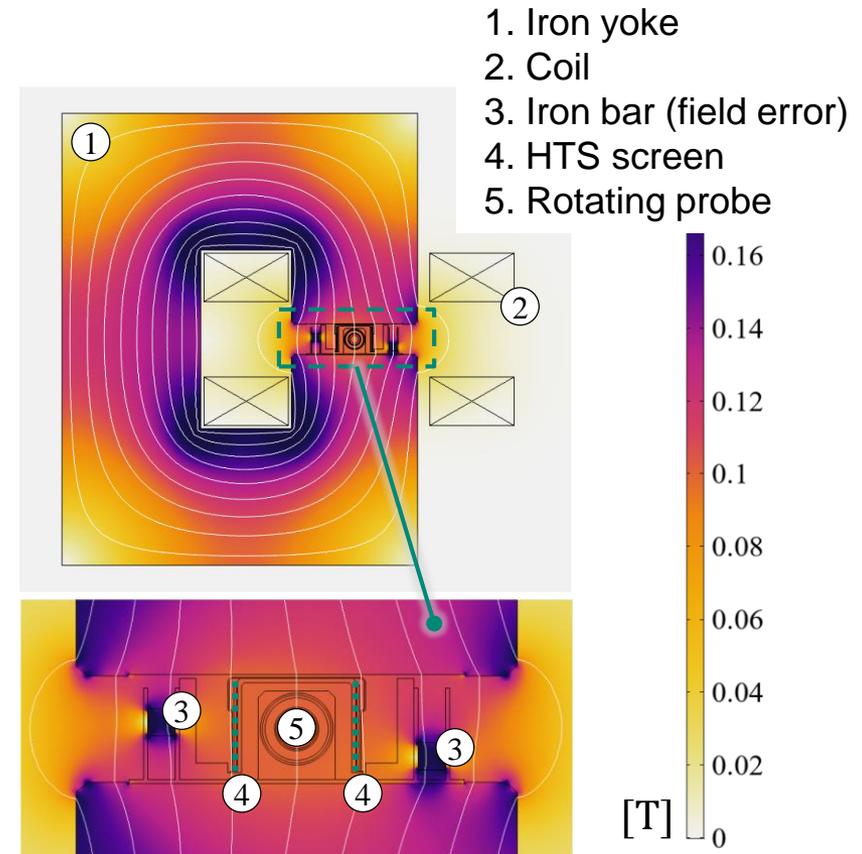
Key features:

1. Magnetic field lines shaped by persistent screening currents
2. Cancellation only of undesired field components (static and dynamic)
3. Passive and self-regulating



Quasi-perfect electric wall

Proof of concept design



(D) PROTOTYPES DEVELOPMENT (2/2)

Experimental setup



HTS screen



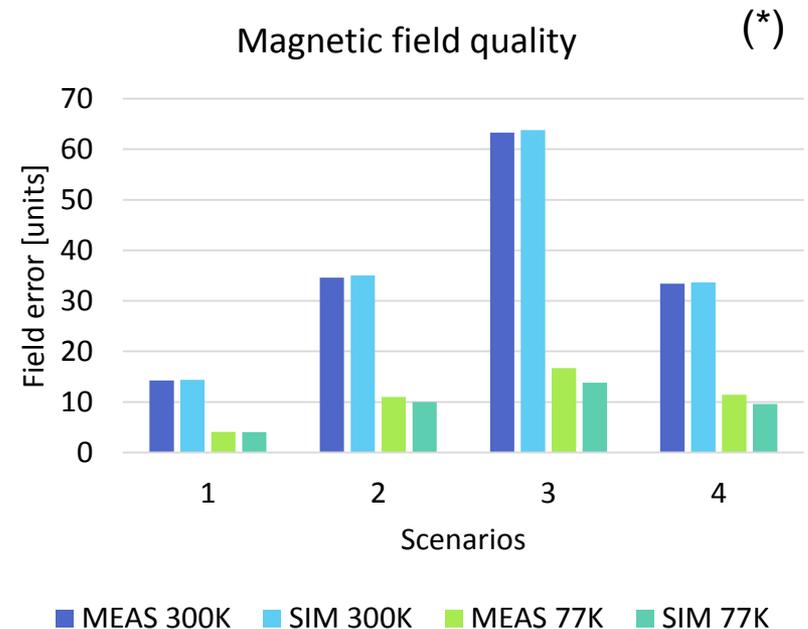
Screen holder



Experimental setup at cold

Experimental and numerical result

Magnetic field quality (total harmonic distortion) in the magnet aperture, without and with HALO



2~4 factor in field quality improvement

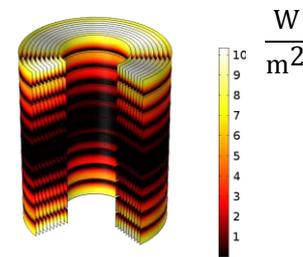
CONCLUSIONS AND OUTLOOK

Conclusions

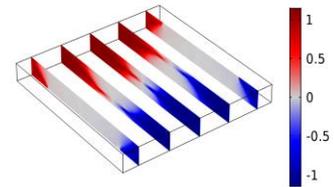
1. Transient effects in accelerators: **multi physics, scale and rate** phenomena
2. **Specialized models + Co-simulation** for multi rate problems
3. **A-H coupled field formulation** for superconductors
4. **High sensitivity** to tape parameters **characterization** of paramount importance

Outlook – HTS models

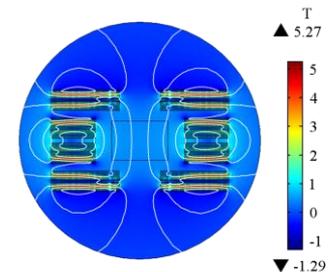
1. **Very Good understanding about 2D models**
What is missing?
What are the next challenges?
2. **Major challenge in full-scale 3D models**
Brute-force (cluster computing)?
Homogenization (anisotropic resistance)?



Ohmic loss distribution
in a HTS solenoid



normalized induced
current in a HTS bulk



Persistent magnetization
in a block-coil dipole

Thank you for your attention!

Contact: lorenzo.bortot@cern.ch

Annex

HTS SOLENOID: CIRCUIT PARAMETERS

Parameter	Unit	Value	Description
$i_s(t)$	[A]	-	Source current
$v_{qh}(t)$	[V]	-	Capacitor voltage
S_{crow}	[-]	-	Crowbar switch
S_{qh}	[-]	-	Quench heater switch
R_{crow}	[$\mu\Omega$]	175	Crowbar resistance
R_{cir1}	[$\mu\Omega$]	25	Circuit resistance
R_{cir2}	[m Ω]	10	Circuit resistance
L_{cir1}	[μ F]	10	Circuit Inductance
L_{cir2}	[μ F]	500	Circuit Inductance
$R_m(T_{op})$	[n Ω]	<5	Coil quench resistance
$R_{qh}(T_{op})$	[Ω]	4.5	Quench heater resistance
$L_m(I_s)$	[μ F]	50.7	Coil inductance
$L_{qh}(I_s)$	[μ F]	2.7	Quench heater inductance
$M(I_s)$	[μ F]	0.4	Mutual inductance

CONVERGENCE RATE

Definitions, at iteration i :

- x_i signal (current in the magnet)
- ε_{abs} ε_{rel} absolute & relative error
- ε_i convergence error
- F_{conv} convergence flag

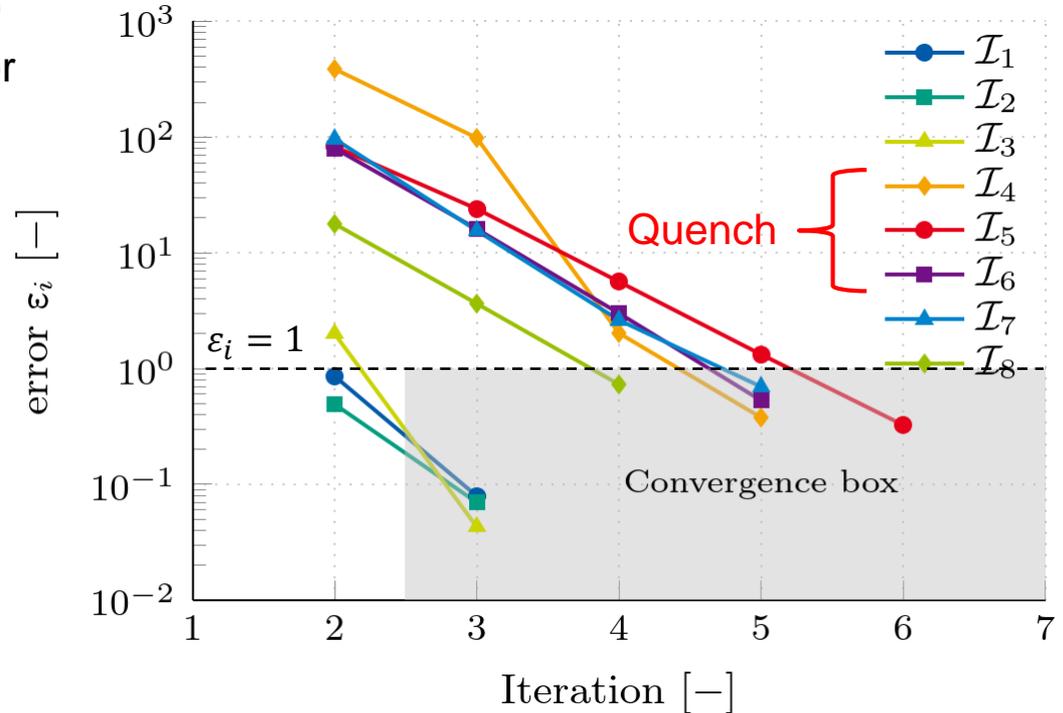
$$\varepsilon_i = \max\left(\frac{|x_i - x_{i-1}|}{\varepsilon_{abs} + |x_i|\varepsilon_{rel}}\right), \quad i \geq 2$$

$$F_{conv} = \begin{cases} 0, & \text{if } i < 2 \\ \varepsilon_i < 1, & \text{if } i \geq 2 \end{cases}$$

Enforcement of at least three iterations per time window

$$\varepsilon_{abs} = 0.001$$

$$\varepsilon_{rel} = 0.25$$



Quench as abrupt change in resistivity

→ High influence on the solenoid current

→ More iterations needed!